## **IGBT**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for half bridge resonant applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

#### **Features**

- Low Saturation Voltage using Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb-Free Devices

#### **Typical Applications**

• Inverter Welding

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	lc	120 60	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I <sub>F</sub>	120 60	А
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>CM</sub>	240	Α
Diode pulsed current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>FM</sub>	240	Α
Gate-emitter voltage	$V_{GE}$	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	298 119	W
Operating junction temperature range	$T_J$	-55 to +150	°C
Storage temperature range	T <sub>stg</sub>	-55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

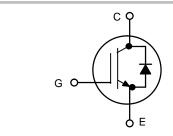
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

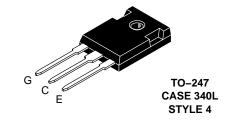


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60 A, 600 V V<sub>CEsat</sub> = 2.0 V E<sub>off</sub> = 0.60 mJ





#### **MARKING DIAGRAM**



A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB60N60SWG	TO-247 (Pb-Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ heta JC}$	0.42	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ heta JC}$	1.00	°C/W
Thermal resistance junction-to-ambient	$R_{ heta JA}$	40	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit	
STATIC CHARACTERISTIC							
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 \text{ V, I}_{C} = 500 \mu\text{A}$	V <sub>(BR)CES</sub>	600	-	-	V	
Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 60 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 60 A, T <sub>J</sub> = 150°C	V <sub>CEsat</sub>	- -	2.0 2.6	2.5 -	V	
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_{C} = 150 \mu A$	$V_{GE(th)}$	4.5	5.5	6.5	V	
Collector-emitter cut-off current, gate- emitter short-circuited	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 600 V, T <sub>J</sub> = 150°C	I <sub>CES</sub>	<u>-</u> -		0.2 2	mA	
Gate leakage current, collector–emitter short–circuited	V <sub>GE</sub> = 20 V , V <sub>CE</sub> = 0 V	I <sub>GES</sub>	-	_	200	nA	
DYNAMIC CHARACTERISTIC							
Input capacitance		C <sub>ies</sub>	-	4112	_	pF	
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	-	169	-	1	
Reverse transfer capacitance	1	C <sub>res</sub>	-	107	_	1	
Gate charge total		$Q_g$		173		nC	
Gate to emitter charge	$V_{CE} = 480 \text{ V}, I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	Q <sub>ge</sub>		38		1	
Gate to collector charge	1	Q <sub>gc</sub>		87		1	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD	•		•		•	
Turn-on delay time		t <sub>d(on)</sub>		87		ns	
Rise time	1	t <sub>r</sub>		48		1	
Turn-off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 400 \text{ V, } I_C = 60 \text{ A}$	t <sub>d(off)</sub>		180		1	
Fall time	$R_g = 10 \Omega$ $V_{GE} = 0 \text{ V/ } 15 \text{ V}$	t <sub>f</sub>		70		1	
Turn-off switching loss	VGE = 0 V/ 13 V	E <sub>off</sub>		0.60		mJ	
Turn-on switching loss	1	E <sub>on</sub>		1.41		1	
Turn-on delay time		t <sub>d(on)</sub>		85		ns	
Rise time	1	t <sub>r</sub>		50		1	
Turn-off delay time	$T_J = 150$ °C $V_{CC} = 400 \text{ V, } I_C = 60 \text{ A}$	t <sub>d(off)</sub>		186		1	
Fall time	$R_g = 10 \Omega$ $V_{GE} = 0 \text{ V/} 15 \text{ V}$	t <sub>f</sub>		91		1	
Turn-off switching loss	VGE = 0 V/ 15 V	E <sub>off</sub>		1.11		mJ	
Turn-on switching loss	1	E <sub>on</sub>		1.77			
DIODE CHARACTERISTIC	•			•	•	•	
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 30 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 30 A, T <sub>J</sub> = 150°C	V <sub>F</sub>		1.98 2.10	2.30	V	
Reverse recovery time	T <sub>J</sub> = 25°C	t <sub>rr</sub>		76		ns	
Reverse recovery charge	$I_F = 30 \text{ Å}, V_R = 200 \text{ V}$ $di_F/dt = 200 \text{ A}/\mu \text{s}$	Q <sub>rr</sub>		291		nc	
Reverse recovery current	1	I <sub>rrm</sub>		7		Α	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

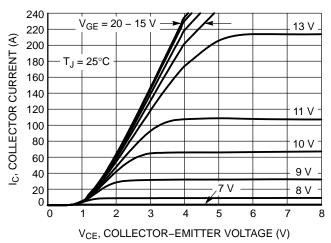


Figure 1. Output Characteristics

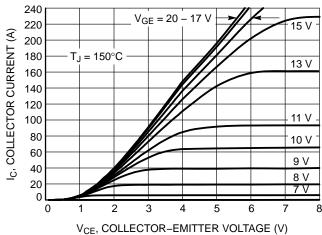


Figure 2. Output Characteristics

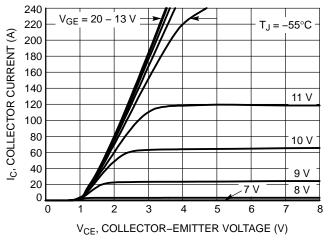
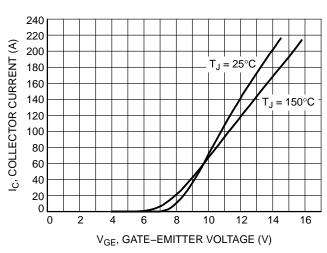


Figure 3. Output Characteristics



**Figure 4. Typical Transfer Characteristics** 

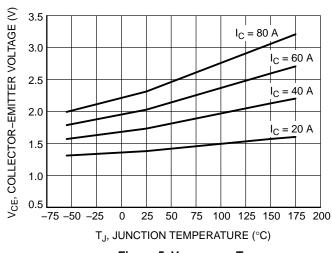


Figure 5. V<sub>CE(sat)</sub> vs. T<sub>J</sub>

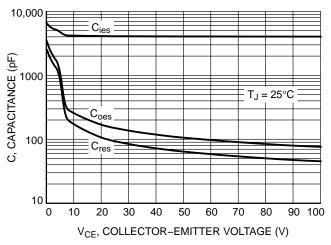
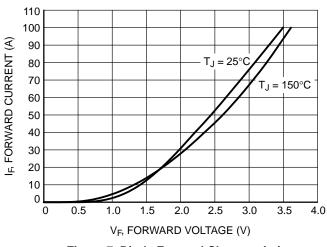


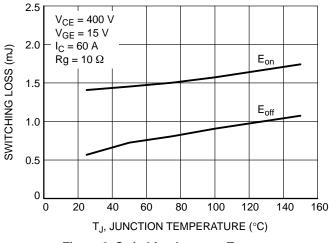
Figure 6. Typical Capacitance



20 V<sub>GE</sub>, GATE-EMITTER VOLTAGE (V) 18 16 14 12 10 8 V<sub>CE</sub> = 480 V 6 V<sub>GE</sub> = 15 V  $I_{C} = 60 \text{ A}$ 2 0 20 100 120 140 160 180 200 0 40 80 QG, GATE CHARGE (nC)

Figure 7. Diode Forward Characteristics

Figure 8. Typical Gate Charge



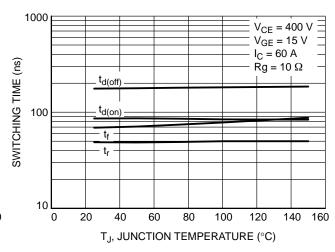
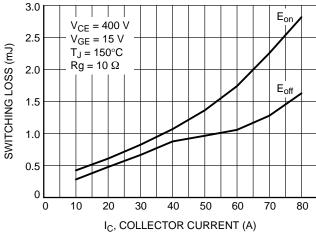


Figure 9. Switching Loss vs. Temperature

Figure 10. Switching Time vs. Temperature



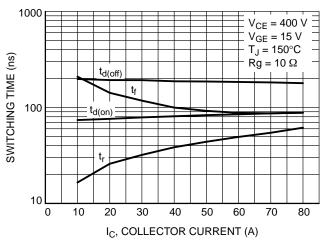


Figure 11. Switching Loss vs. I<sub>C</sub>

Figure 12. Switching Time vs. I<sub>C</sub>

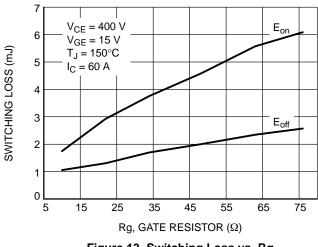


Figure 13. Switching Loss vs. Rg

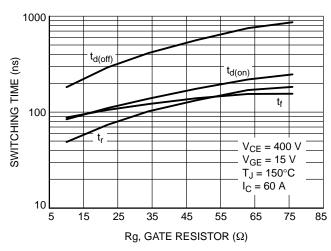


Figure 14. Switching Time vs. Rg

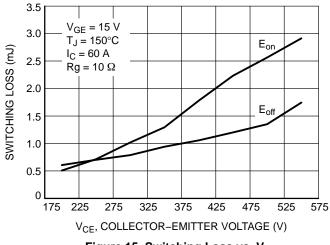


Figure 15. Switching Loss vs. V<sub>CE</sub>

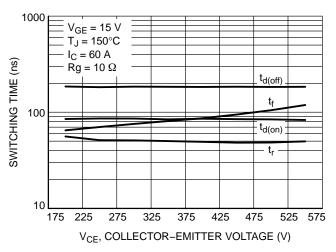


Figure 16. Switching Time vs. V<sub>CE</sub>

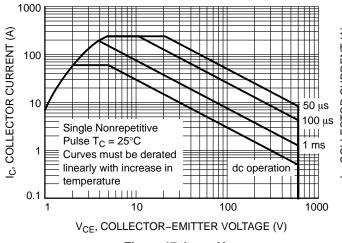


Figure 17. I<sub>C</sub> vs. V<sub>CE</sub>

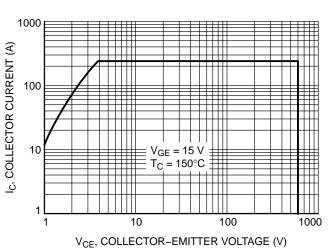


Figure 18. I<sub>C</sub> vs. V<sub>CE</sub>

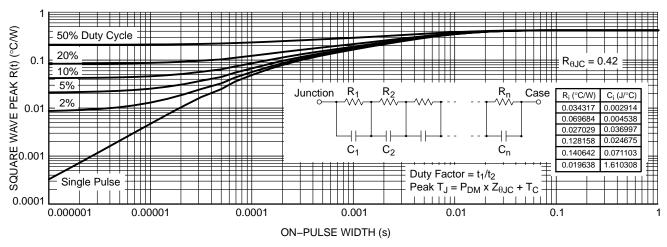


Figure 19. IGBT Transient Thermal Impedance

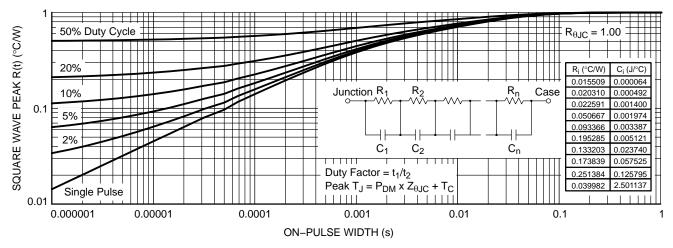
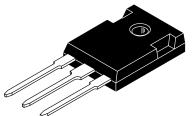


Figure 20. Diode Transient Thermal Impedance





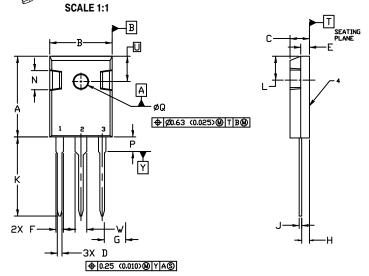
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**DATE 06 OCT 2021** 

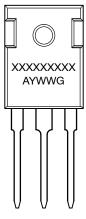
#### NOTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ε	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
К	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242	BSC
W	2.87	3.12	0.113	0.123



# GENERIC MARKING DIAGRAM\*



STYLE 1:	
PIN 1.	GATE
2.	DRAIN
3.	SOURCE
4.	DRAIN

STYLE 2:
PIN 1. ANODE
2. CATHODE (S)
3. ANODE 2
4. CATHODES (S)

STYLE 3:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

STYLE 4:
PIN 1. GATE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

XXXXX = Specific Device Code A = Assembly Location

Y = Year
WW = Work Week
G = Pb-Free Package

 STYLE 5:
 STYLE 6:

 PIN 1. CATHODE
 PIN 1. MAIN TERMINAL 1

 2. ANODE
 2. MAIN TERMINAL 2

 3. GATE
 3. GATE

 4. ANODE
 4. MAIN TERMINAL 2

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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 TIG058E8-TL-H
 VS-CPV364M4KPBF
 NGTB25N120FL2WAG
 NGTG40N120FL2WG
 RJH60F3DPQ-A0#T0

 APT40GR120B2SCD10
 APT15GT120BRG
 APT20GT60BRG
 NGTB75N65FL2WAG
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 IXA30RG1200DHGLB

 IXA40RG1200DHGLB
 APT70GR65B2DU40
 NTE3320
 IHFW40N65R5SXKSA1
 APT70GR120J
 APT35GP120JDQ2

 IKZA40N65RH5XKSA1
 IKFW75N65ES5XKSA1
 IKFW50N65ES5XKSA1
 IKFW50N65EH5XKSA1
 IKFW40N65ES5XKSA1

 IKFW60N65ES5XKSA1
 IMBG120R090M1HXTMA1
 IMBG120R220M1HXTMA1
 XD15H120CX1
 XD25H120CX0
 XP15PJS120CL1B1

 IGW30N60H3FKSA1
 STGWA8M120DF3
 IGW08T120FKSA1
 IGW75N60H3FKSA1
 HGTG40N60B3
 FGH60N60SMD\_F085

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 STGWA15H120F2
 IKA10N60TXKSA1
 IHW20N120R5XKSA1
 RJH60D2DPP-M0#T2
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